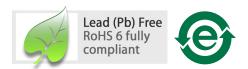
# HSMx-A43x-xxxxx

# Surface Mount LED Indicator



# **Data Sheet**





### **Description**

The Power PLCC-4 SMT LED with Lens are high-performance PLCC-4 package size SMT LEDs targeted mainly in Automotive & Electronics Signs and Signals (ESS) markets. These top-mount single-chip packages with focused radiation offer high brightness in beam direction and are excellent for interior automotive, indoor and outdoor sign and industrial applications. With additional lens in 30° variants, these products are especially fitting to applications for traffic lights, CHMSL and displays.

The PLCC-4 package family is able to dissipate heat better compared to the PLCC-2 packages. In proportion to this increase in driving current, this family of LEDs is able to produce higher light output compared to the conventional PLCC-2 SMT LEDs.

As an extension of the standard flat top PLCC-4 SMT LEDs, the Power PLCC-4 with Lens device is able to provide focused beams within narrow viewing angles (30°) meeting the market's requirements for focused radiation and high brightness in beam directions.

The Power PLCC-4 SMT LED with 30° is ideal for panel, push button, or general backlighting in automotive interior & exterior, sign, office equipment, industrial equipment and home appliances applications. This package design coupled with careful selection of component materials allow the Power PLCC-4 SMT LED with Lens to perform with higher reliability in a larger temperature range -40°C to 100°C. This high reliability feature is crucial to allow the Power PLCC-4 SMT LED with Lens to do well in harsh environments such as its target Automotive & ESS markets. The Power PLCC4 SMT LED with Lens package is also designed to be compatible with both IR-solder re-flow and throughthe-wave soldering.

#### **Features**

- Industry Standard PLCC-4
- High reliability LED package
- High brightness using AllnGaP and InGaN dice technologies
- · High optical efficiency
- Narrow Viewing angle at 30°
- Available in 8mm carrier tape on 7-inch reel
- Compatible with both IR and TTW soldering process

## **Applications**

#### Interior automotive

- Instrument panel backlighting
- Central console backlighting
- Cabin backlighting
- Navigation and audio system
- Dome lighting
- Push button backlighting

### **Exterior automotive**

- Turn signals
- CHMSL
- Rear Combination Lamp
- Side repeaters

#### Electronic signs and signals

- Interior and exterior full color sign
- Variable message sign
- Garden lighting

### Office automation, home appliances, industrial equipment

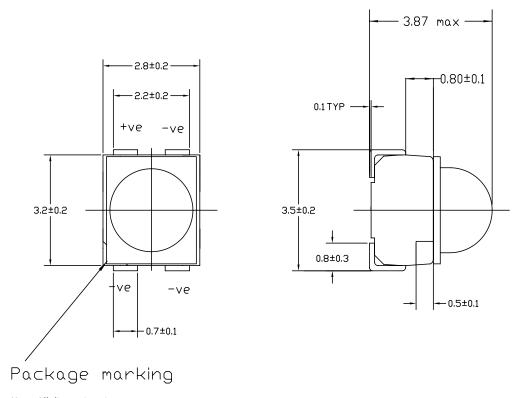
- Front panel backlighting
- Push button backlighting
- Display backlighting

**CAUTION:** HSMN, HSMM-A43x-xxxxx LEDs are Class 2 ESD sensitive. Please observe appropriate precautions during handling and processing. Refer to Avago Application Note AN-1142 for additional details.

The new Avago Technologies Power PLCC-4 SMT LED with 30° Lens will carry the part number HSMx- A43xxxxxx. The high brightness AlInGaP and InGaN dice technologies utilized will provide the product brightness that meets the Automotive and ESS markets requirements. The Lens package will complement and complete the existing AlInGap & InGaN color standard Power-PLCC-4 LED that Avago Technologies offers, providing customers an extra Lens option from one supplier.

To facilitate easy pick and place assembly, the LEDs are packed in EIA-compliant tape and reel. Every reel will be shipped in single intensity and color bin (except for red color), to provide close uniformity

# **Package Dimensions**



Note: All dimensions in mm Electrical connection between all cathodes is recommended

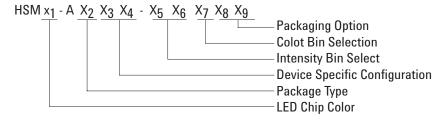
## **Device Selection Guide**

Color	Davit Novah av	Min I (mad)	Turn I (massl)	Mary I (mad)	Test Current	Dice
Color	Part Number	Min. I <sub>V</sub> (mcd)	Typ. I <sub>V</sub> (mcd)	Max. I <sub>V</sub> (mcd)	(mA)	Technology
Red	HSMC-A430-W50M1	1125.00	2300.00	3550.00	50	AlInGaP
	HSMC-A431-X90M1	2240.00	4000.00	7150.00	50	AlInGaP
Red Orange	HSMJ-A430-W50M1	1125.00	2300.00	3550.00	50	AlInGaP
	HSMJ-A431-X90M1	2240.00	4500.00	7150.00	50	AlInGaP
	HSMV-A430-Y90M1	3500.00	6000.00	11250.00	50	AlInGaP
Orange	HSML-A431-X90M1	2240.00	4500.00	7150.00	50	AlInGaP
Amber	HSMA-A430-W90M1	1400.00	3000.00	4500.00	50	AlInGaP
	HSMA-A431-Y00M1	2850.00	5000.00	-	50	AlInGaP
	HSMA-A431-X90M1	2240.00	4700.00	7150.00	50	AlInGaP
Green	HSMM-A430-W90M2	1400.00	2400.00	4500.00	30	InGaN
Blue	HSMN-A430-U50M2	450.00	950.00	1400.00	30	InGaN
	HSMN-A431-T50M2	285.00	360.00	900.00	30	InGaN

#### Notes:

- 1. The luminous intensity l<sub>V</sub>, is measured at the mechanical axis of the lamp package. The actual peak of the spatial radiation pattern may not be aligned with this axis.
- 2. Iv tolerance  $\pm 12\%$

# **Part Numbering System**



# Absolute Maximum Ratings (T<sub>A</sub>=25°C)

Parameters	HSMC/A	HSMV	HSMM/N
DC Forward Current [1]	70 mA	70 mA	30 mA
Peak Forward Current [2]	200 mA	200 mA	90 mA
Power Dissipation	180 mW	240 mW	114 mW
Reverse Voltage	5V	5V	4V
Junction Temperature	110 °C		
Operating Temperature	- 40 °C to + 100	°C	
Storage Temperature	- 40 °C to + 100	°C	

#### Notes

- 1. Derate linearly as shown in Figure 4.
- 2. Duty factor = 10%, Frequency = 1kHz

# Optical Characteristics ( $T_A = 25$ °C)

	Dice	Wavelength $\lambda_{PEAK}$ (nm)	Dominant Wavelength $\lambda_D^{[1]}$ (nm)	2 $\theta_{1/2}^{[2]}$ (Degrees)	Efficacy ην <sup>[3]</sup> (lm/W)
Part Number	Technology	Typical	Typical	Typical	Typical
HSMC-A43x	AlInGaP	635	626	30	150
HSMJ-A43x	AlInGaP	621	615	30	240
HSMV-A430	AlInGaP	623	617	30	263
HSML-A431	AlInGaP	609	605	30	320
HSMA-A43x	AlInGaP	592	590	30	480
HSMM-A430	InGaN	518	525	30	500
HSMN-A43X	InGaN	468	470	30	75
	HSMC-A43x HSMJ-A43x HSMV-A430 HSML-A431 HSMA-A43x HSMM-A430	Part Number Technology HSMC-A43x AllnGaP HSMJ-A43x AllnGaP HSMV-A430 AllnGaP HSML-A431 AllnGaP HSMA-A43x AllnGaP HSMA-A43x InGaP	Part Number         Dice Technology         λγΕΑΚ (nm)           HSMC-A43x         AlInGaP         635           HSMJ-A43x         AlInGaP         621           HSMV-A430         AlInGaP         623           HSML-A431         AlInGaP         609           HSMA-A43x         AlInGaP         592           HSMM-A430         InGaN         518	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Part Number         λPEAK (nm)         length λD[1] (nm)         (Degrees)           HSMC-A43x         AllnGaP         635         626         30           HSMJ-A43x         AllnGaP         621         615         30           HSMV-A430         AllnGaP         623         617         30           HSML-A431         AllnGaP         609         605         30           HSMA-A43x         AllnGaP         592         590         30           HSMM-A430         InGaN         518         525         30

#### Notes:

- $1. \ \ \, \text{The dominant wavelength, } \\ \lambda_{D\text{, is derived from the CIE Chromaticity Diagram and represents the color of the device.} \\$
- 2.  $\theta$ ½ is the off-axis angle where the luminous intensity is ½ the peak intensity.
- 3. Radiant intensity, le in watts / steradian, may be calculated from the equation le =  $I_V / \eta_V$ , where  $I_V$  is the luminous intensity in candelas and  $\eta_V$  is the luminous efficacy in lumens / watt.

# Electrical Characteristics (T<sub>A</sub> = 25 °C)

	Forward Voltage	e V <sub>F</sub> (Volts)@I <sub>F</sub> =50 mA	Reverse Voltage $V_R@100\mu A$	Reverse Voltage $V_R@10\mu\text{A}$
Part Number	Typical	Maximum	Minimum	Minimum
HSMC/J/L/A	2.2	2.5	5	-
HSMV	2.8	3.4	5	-

	Forward Voltag	e V <sub>F</sub> (Volts)@I <sub>F</sub> =30 mA	Reverse Voltage V <sub>R</sub> @100μA	Reverse Voltage V <sub>R</sub> @10μA
Part Number	Typical	Maximum	Minimum	Minimum
HSMM/N	3.9	4.6	-	5

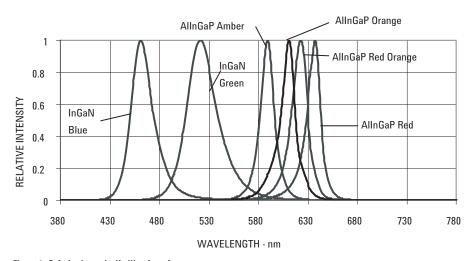


Figure 1. Relative Intensity Vs. Wavelength

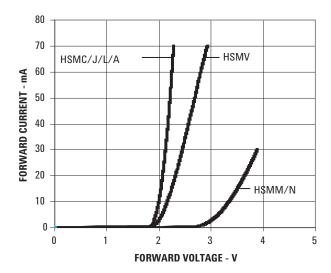


Figure 2. Forward Current Vs. Forward Voltage

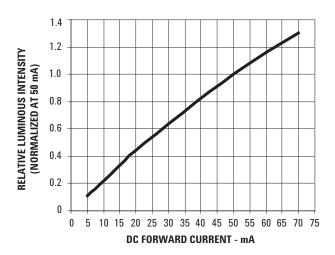


Figure 3a. Relative Intensity Vs. Forward Current (AlInGaP).

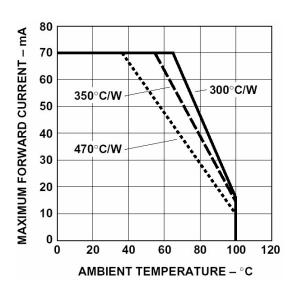


Figure 4a. Maximum Forward Current Vs. Ambient Temperature. Derated Based on Tymax=  $110^{\circ}$ C (AlInGaP)

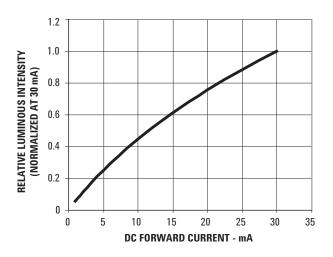


Figure 3b. Relative Intensity Vs. Forward Current (InGaN).

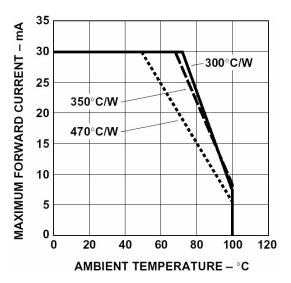


Figure 4b. Maximum Forward Current Vs. Ambient Temperature.

Derated Based on T<sub>J</sub>max= 110°C (InGaN)

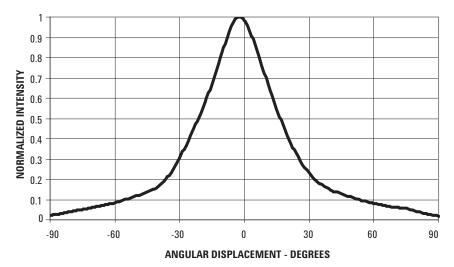


Figure 5. Radiation Pattern

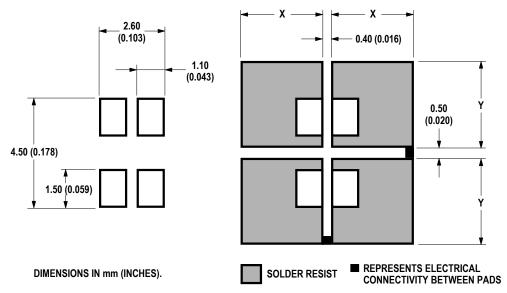


Figure 6a. Recommended Soldering Pad Pattern (IR Reflow).

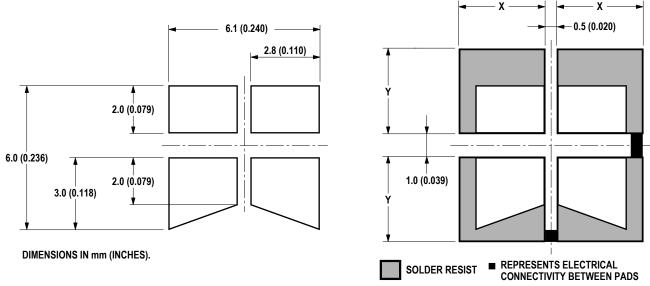


Figure 6b. Recommended Soldering Pad Pattern (TTW).

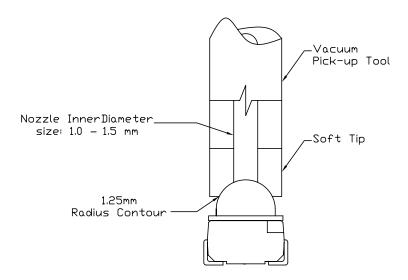


Figure 7. Soft Tip Vacuum Pick-up Tool for Extracting SMT LED Components from Carrier Tape.

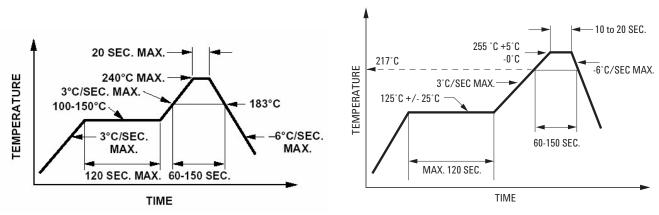


Figure 8a. Recommended SnPb Reflow Soldering Profile

Figure 8b. Recommended Pb-free Reflow Soldering Profile.

Note: For detail information on reflow soldering of Avago surface mount LEDs, do refer to Avago Application Note AN 1060 Surface Mounting SMT LED Indicator Components.

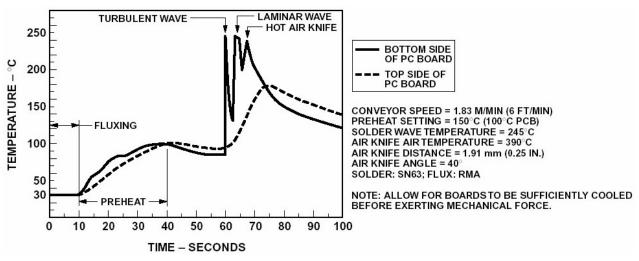


Figure 9. Recommended Wave Soldering Profile.

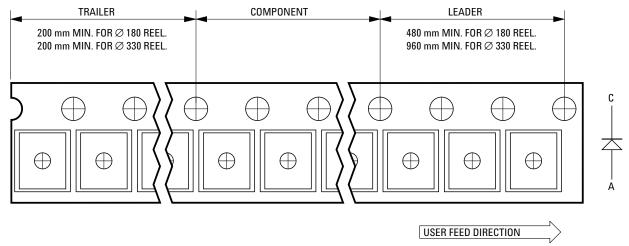


Figure 10. Tape Leader and Trailer Dimensions

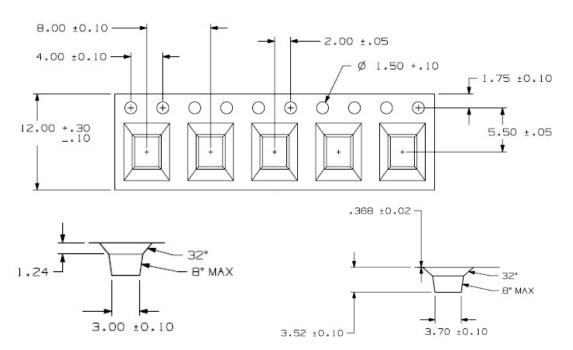


Figure 11. Tape Dimensions

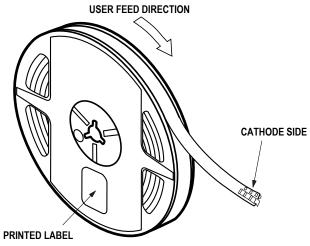


Figure 12. Reeling Orientation.

## **Moisture Sensitivity**

This product is qualified as Moisture Sensitive Level 2a per Jedec J-STD-020. Precautions when handling this moisture sensitive product is important to ensure the reliability of the product. Do refer to Avago Application Note AN5305 Handling of Moisture Sensitive Surface Mount Devices for details.

## A. Storage before use

- Unopen moisture barrier bag (MBB) can be stored at <40°C/90%RH for 12 months. If the actual shelf life has exceeded 12 months and the HIC indicates that baking is not required, then it is safe to reflow the LEDs per the original MSL rating.
- It is not recommended to open the MBB prior to assembly (e.g. for IQC).

# B. Control after opening the MBB

- The humidity indicator card (HIC) shall be read immediately upon opening of MBB.
- The LEDs must be kept at <30°C / 60%RH at all time and all high temperature related process including soldering, curing or rework need to be completed within 672 hours.

### C. Control for unfinished reel

 For any unuse LEDs, they need to be stored in sealed MBB with desiccant or desiccator at <5%RH.</li>

### D. Control of assembled boards

 If the PCB soldered with the LEDs is to be subjected to other high temperature processes, the PCB need to be stored in sealed MBB with desiccant or desiccator at <5%RH to ensure no LEDs have exceeded their floor life of 672 hours.

### E. Baking is required if:

- "10%" or "15%" HIC indicator turns pink.
- The LEDs are exposed to condition of >30°C / 60% RH at any time.
- The LEDs floor life exceeded 672 hours.

Recommended baking condition: 60±5°C for 20 hours.

# Intensity Bin Select (X<sub>5</sub>X<sub>6</sub>)

Individual reel will contain parts from one half bin only

Х <sub>5</sub>	Min Iv Bin
$X_6$	
0	Full Distribution
3	3 half bins starting from X <sub>5</sub> 1
4	4 half bins starting from X <sub>5</sub> 1
5	5 half bins starting from X <sub>5</sub> 1
7	3 half bins starting from X <sub>5</sub> 2
8	4 half bins starting from X <sub>5</sub> 2
9	5 half bins starting from X <sub>5</sub> 2

## **Intensity Bin Limits**

Bin ID	Min (mcd)	Max (mcd)
W1	1125.00	1400.00
W2	1400.00	1800.00
X1	1800.00	2240.00
X2	2240.00	2850.00
Y1	2850.00	3550.00
Y2	3550.00	4500.00
Z1	4500.00	5600.00
Z2	5600.00	7150.00
11	7150.00	9000.00
12	9000.00	11250.00
21	11250.00	14000.00
22	14000.00	18000.00

Tolerance of each bin limit =  $\pm 12\%$ 

# Color Bin Select (X<sub>7</sub>)

Individual reel will contain parts from 1 full bin only

Х7	
0	Full Distribution
Z	A and B only
Υ	B and C only
W	C and D only
V	D and E only
U	E and F only
T	F and G only
S	G and H only
Q	A, B and C only
Р	B, C and D only
N	C, D and E only
М	D, E and F only
L	E, F and G only
K	F, G and H only
1	A, B, C and D only
2	E, F G and H only

## **Color Bin Limits**

Blue	Min. (nm)	Max. (nm)
Α	460.0	465.0
В	465.0	470.0
С	470.0	475.0
D	475.0	480.0
Cyan	Min. (nm)	Max. (nm)
<b>Cyan</b> A	<b>Min. (nm)</b> 490.0	<b>Max. (nm)</b> 495.0
		• • • • • • • • • • • • • • • • • • • •
A	490.0	495.0
A B	490.0 495.0	495.0 500.0

Green	Min. (nm)	Max. (nm)
Α	515.0	520.0
В	520.0	525.0
С	525.0	530.0
D	530.0	535.0

Amber	Min. (nm)	Max. (nm)
Α	582.0	584.5
В	584.5	587.0
С	587.0	589.5
D	589.5	592.0
Е	592.0	594.5
F	594.5	597.0
		*

Red	Min. (nm)	Max. (nm)
Full Distri-		
bution		

Tolerance of each bin limit =  $\pm 1$ nm

# Packaging Option (X<sub>8</sub>X<sub>9</sub>)

Option	Test Current	Package Type	Reel Size
M1	50mA	Top Mount	13 inch
M2	30mA	Top Mount	13 inch

# **Forward Voltage Bin Table**

For HSMV – A43x-xxxxx only

Bin Min. Max.	
bin Min. Max.	
VA 1.9 2.2	
VB 2.2 2.5	
VC 2.5 2.8	
VD 2.8 3.1	
VE 3.1 3.4	

Tolerance for each bin limit =  $\pm$  0.1V